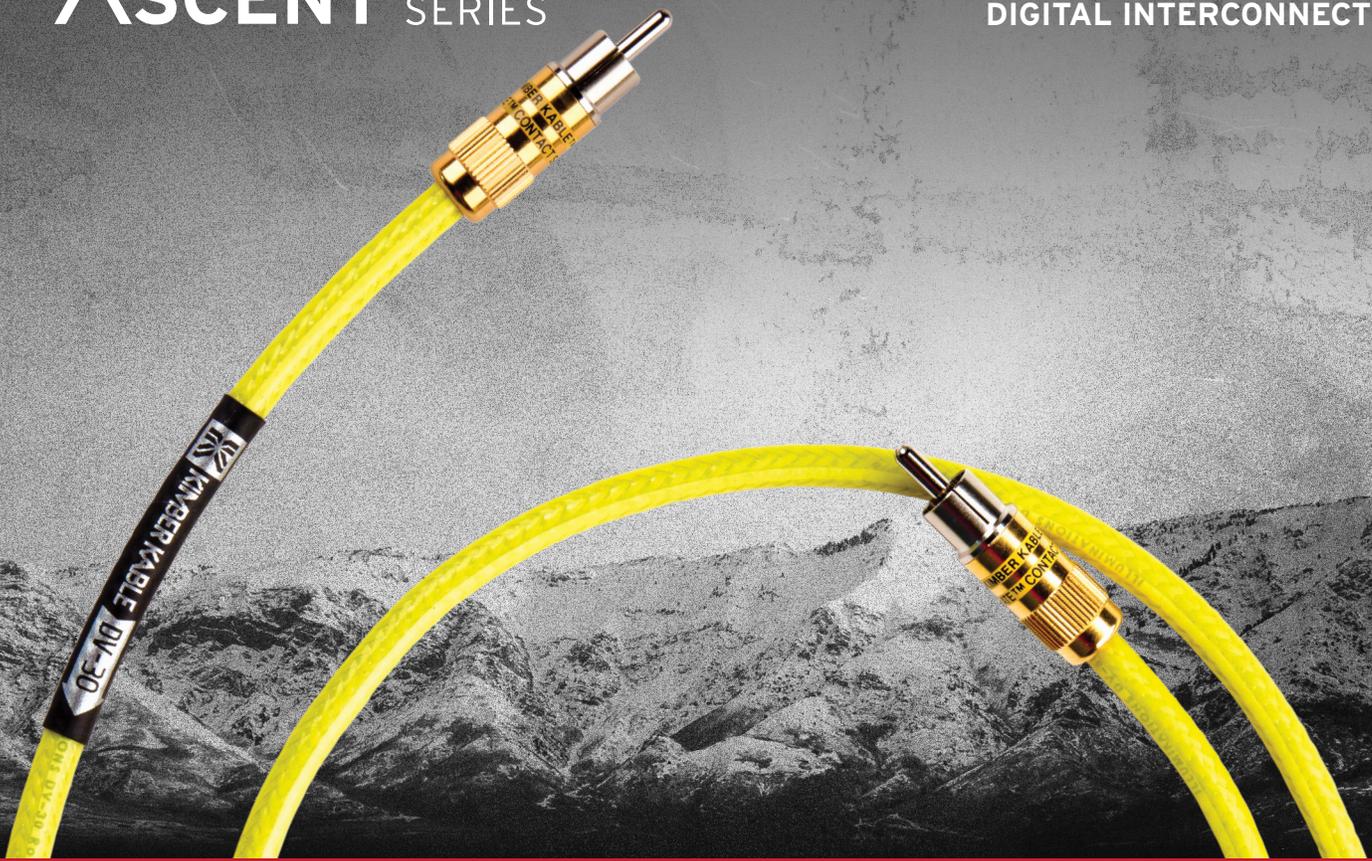


ASCENT SERIES

DIGITAL INTERCONNECTS



# DV-30

## PUSH EVERY BIT

RG6 based high purity copper and foamed FEP dielectric offer increased bandwidth over the V21. Longer lengths are no problem for DV30.

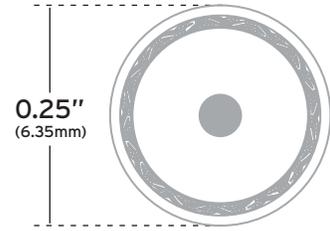
Dual shield (Aluminum Mylar & Tin plated copper)

Low loss FEP foam dielectric

Copper conductor

## DV-30

## DIGITAL INTERCONNECTS



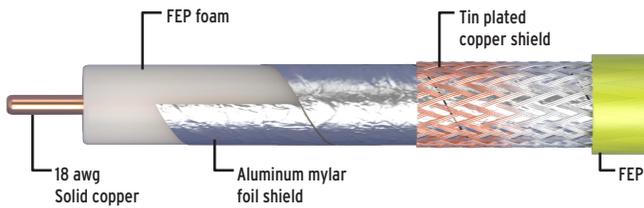
0.25"  
(6.35mm)

 **Dual shield**  
(Aluminum Mylar & Tin plated copper)

Solid copper center conductor

 Nitrogen assisted  
hand soldered termination

 Low loss fluorocarbon dielectric



### ELECTRICAL SPECIFICATIONS

DUT: DV-30 1m terminated with Ultraplate RCA type connectors

(Cp) parallel capacitance:	62.5 pF
(Ls) series inductance:	0.505 $\mu$ H
(Rdc) dc loop resistance:	0.114 $\Omega$

### RECOMMENDED CONNECTOR OPTIONS:



WBT-0102 CU

"F" type

BNC type

ULTRAPLATE